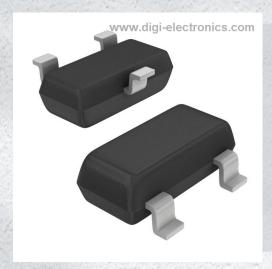


2V7002KT1G Datasheet



https://www.DiGi-Electronics.com

DiGi Electronics Part Number 2V7002KT1G-DG

Manufacturer onsemi

Manufacturer Product Number 2V7002KT1G

Description MOSFET N-CH 60V 320MA SOT23

Detailed Description N-Channel 60 V 320mA (Ta) 300mW (Tj) Surface Mo

unt SOT-23-3 (TO-236)



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.



Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
2V7002KT1G	onsemi
Series:	Product Status:
	Active
FET Type:	Technology:
N-Channel	MOSFET (Metal Oxide)
Drain to Source Voltage (Vdss):	Current - Continuous Drain (Id) @ 25°C:
60 V	320mA (Ta)
Drive Voltage (Max Rds On, Min Rds On):	Rds On (Max) @ ld, Vgs:
4.5V, 10V	1.60hm @ 500mA, 10V
Vgs(th) (Max) @ ld:	Gate Charge (Qg) (Max) @ Vgs:
2.3V @ 250μA	0.7 nC @ 4.5 V
Vgs (Max):	Input Capacitance (Ciss) (Max) @ Vds:
±20V	24.5 pF @ 20 V
FET Feature:	Power Dissipation (Max):
	300mW (Tj)
Operating Temperature:	Grade:
-55°C ~ 150°C (TJ)	Automotive
Qualification:	Mounting Type:
AEC-Q101	Surface Mount
Supplier Device Package:	Package / Case:
SOT-23-3 (TO-236)	TO-236-3, SC-59, SOT-23-3
Base Product Number:	
2V7002	

Environmental & Export classification

8541.21.0095

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	



www.onsemi.com

Small Signal MOSFET

60 V, 380 mA, Single, N-Channel, SOT-23

2N7002K, 2V7002K

Features

- ESD Protected
- Low R_{DS(on)}
- Surface Mount Package
- 2V Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- Low Side Load Switch
- Level Shift Circuits
- DC-DC Converter
- Portable Applications i.e. DSC, PDA, Cell Phone, etc.

MAXIMUM RATINGS (T_J = 25°C unless otherwise stated)

Rating	Symbol	Value	Unit
Drain-to-Source Voltage	V_{DSS}	60	V
Gate-to-Source Voltage	V _{GS}	±20	V
	Ι _D	380 270	mA
	Ι _D	320 230	mA
Power Dissipation Steady State 1 sq in Pad Steady State Minimum Pad	P _D	420 300	mW
Pulsed Drain Current (t _p = 10 μs)	I _{DM}	5.0	Α
Operating Junction and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C
Source Current (Body Diode)	I _S	300	mA
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)	T _L	260	°C
Gate-Source ESD Rating (HBM, Method 3015)	ESD	2000	V

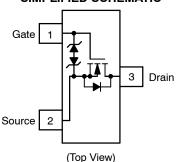
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1

- Surface-mounted on FR4 board using 1 sq in pad size with 1 oz Cu.
 Surface-mounted on FR4 board using 0.08 sq in pad size with 1 oz Cu.

V _{(BR)DSS}	R _{DS(on)} MAX	I _D MAX
60 V	1.6 Ω @ 10 V	380 mA
	2.5 Ω @ 4.5 V	300 IIIA

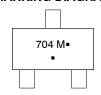
SIMPLIFIED SCHEMATIC





CASE 318

MARKING DIAGRAM



= Device Code 704 = Date Code* = Pb-Free Package

(NOTE: Microdot may be in either location)

*Date Code orientation and/or location may vary depending upon manufacturing location.

ORDERING INFORMATION

Device	Package	Shipping [†]
2N7002KT1G, 2V7002KT1G	SOT-23 (Pb-Free)	3000 / Tape & Reel
2N7002KT7G	SOT-23 (Pb-Free)	3500 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Junction-to-Ambient - Steady State (Note 3)	$R_{\theta JA}$	300	°C/W
Junction-to-Ambient – $t \le 5$ s (Note 3)		92	
Junction-to-Ambient - Steady State (Note 4)		417	
Junction-to-Ambient - t ≤ 5 s (Note 4)		154	

- 3. Surface-mounted on FR4 board using 1 sq in pad size with 1 oz $\,\mathrm{Cu}.$
- 4. Surface-mounted on FR4 board using 0.08 sq in pad size with 1 oz Cu.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Symbol	Test Co	ondition	Min	Тур	Max	Unit
OFF CHARACTERISTICS				•	•	•	-
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 V$,	I _D = 250 μA	60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				71		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V,	T _J = 25°C			1	μΑ
		V _{DS} = 60 V	T _J = 125°C			10	
		V _{GS} = 0 V, V _{DS} = 50 V	T _J = 25°C			100	nA
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V$	V _{GS} = ±20 V			±10	μΑ
		V _{DS} = 0 V,	V _{GS} = ±10 V			450	nA
		V _{DS} = 0 V, V	V _{GS} = ±5.0 V			150	nA
ON CHARACTERISTICS (Note 5)				•	•	•	•
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}$, I _D = 250 μA	1.0		2.3	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				4.0		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	$V_{GS} = 10 \text{ V}, I_D = 500 \text{ mA}$			1.19	1.6	Ω
		V _{GS} = 4.5 V	V _{GS} = 4.5 V, I _D = 200 mA		1.33	2.5	
Forward Transconductance	9FS	V _{DS} = 5 V, I _D = 200 mA			530		mS
CHARGES AND CAPACITANCES							
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 20 V			24.5	45	pF
Output Capacitance	C _{OSS}				4.2	8.0	
Reverse Transfer Capacitance	C _{RSS}	v _{DS}	= 20 V		2.2	5.0	
Total Gate Charge	Q _{G(TOT)}				0.7		nC
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 4.5 V	/, V _{DS} = 10 V;		0.1		
Gate-to-Source Charge	Q_{GS}	I _D = 2	200 mA		0.3		
Gate-to-Drain Charge	Q_{GD}				0.1		
SWITCHING CHARACTERISTICS, V _{GS}	= V (Note 6)						
Turn-On Delay Time	t _{d(ON)}				12.2		ns
Rise Time	t _r	V_{GS} = 10 V, V_{DD} = 25 V, I_{D} = 500 mA, R_{G} = 25 Ω			9.0		
Turn-Off Delay Time	t _{d(OFF)}				55.8		
Fall Time	t _f				29		
DRAIN-SOURCE DIODE CHARACTER	ISTICS						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V,	T _J = 25°C		0.8	1.2	V
		I _S = 200 mA			0.7		1

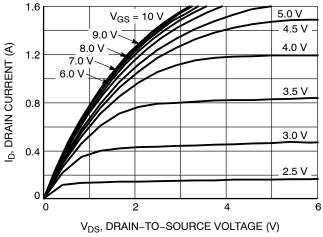
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

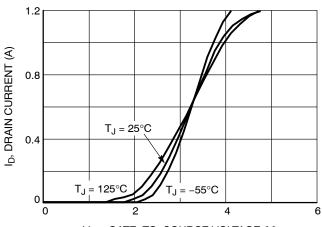


^{5.} Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%

^{6.} Switching characteristics are independent of operating junction temperatures

TYPICAL CHARACTERISTICS





V_{GS}, GATE-TO-SOURCE VOLTAGE (V) Figure 2. Transfer Characteristics

Figure 1. On-Region Characteristics

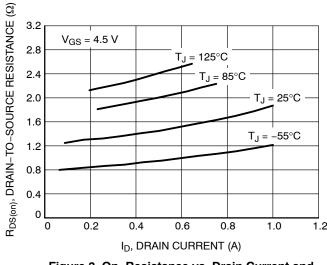


Figure 3. On-Resistance vs. Drain Current and **Temperature**

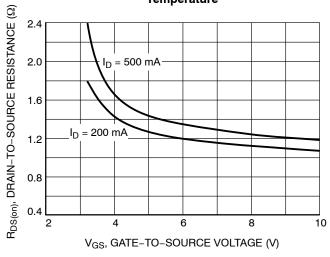


Figure 5. On-Resistance vs. Gate-to-Source Voltage

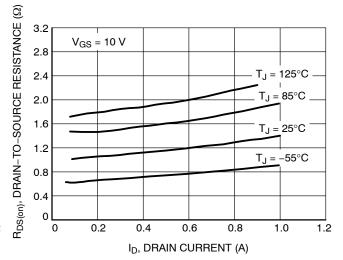


Figure 4. On-Resistance vs. Drain Current and **Temperature**

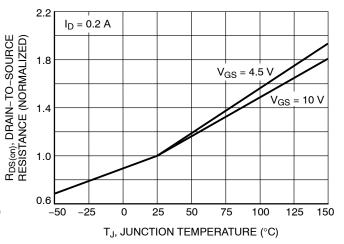
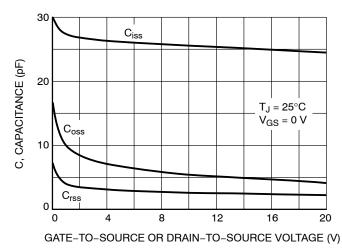


Figure 6. On-Resistance Variation with **Temperature**

TYPICAL CHARACTERISTICS



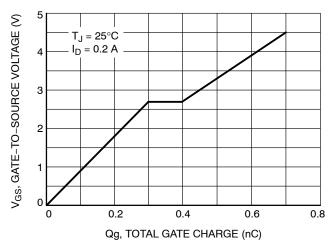
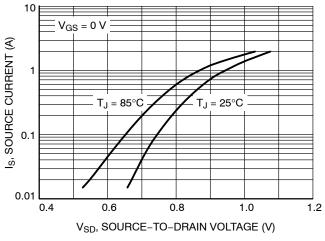


Figure 7. Capacitance Variation

Figure 8. Gate-to-Source and Drain-to-Source Voltage vs. Total Charge



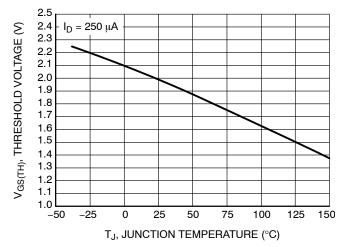


Figure 9. Diode Forward Voltage vs. Current

Figure 10. Threshold Voltage with Temperature

TYPICAL CHARACTERISTICS

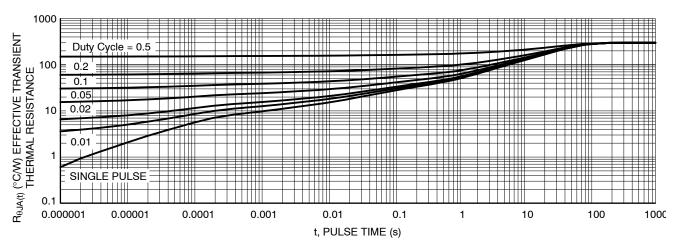


Figure 11. Thermal Response - 1 sq in pad

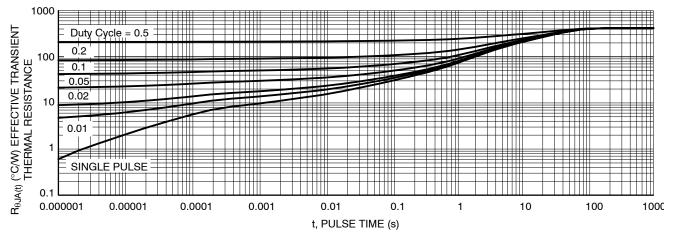


Figure 12. Thermal Response - minimum pad



MECHANICAL CASE OUTLINE

MILLIMETERS

MIN

0.89

0.01

0.37

0.08

2.80

1.20

1.78

0.30

0.35

2.10

O°

DIM

Α

Α1

b

С

D

Ε

е L

L1

HE

Т

NOTES:

NOM

1.00

0.06

0.44

0.14

2.90

1.30

1.90

0.43

0.54

2.40

PACKAGE DIMENSIONS



SOT-23 (TO-236) 2.90x1.30x1.00 1.90P **CASE 318 ISSUE AU**

DATE 14 AUG 2024

MAX

1.11

0.10

0.50

0.20

3.04

1.40

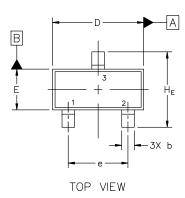
2.04

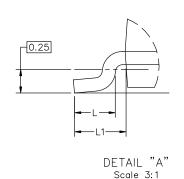
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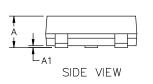
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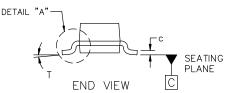
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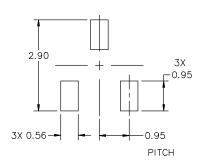
10°











- DIMENSIONING AND TOLERANCING 1. PER ASME Y14.5M, 2018. CONTROLLING DIMENSIONS:
- MILLIMETERS.
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE
- BASE MATERIAL.
 DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

GENERIC MARKING DIAGRAM*



XXX = Specific Device Code

= Date Code

= Pb-Free Package

RECOMMENDED MOUNTING FOOTPRINT

* For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

STYLES ON PAGE 2

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^{*}This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "=", may or may not be present. Some products may not follow the Generic Marking.

SOT-23 (TO-236) 2.90x1.30x1.00 1.90P CASE 318 ISSUE AU

DATE 14 AUG 2024

STYLE 1 THRU 5: CANCELLED	STYLE 6: PIN 1. BASE 2. EMITTER 3. COLLECTOR	STYLE 7: STYLE 8: PIN 1. EMITTER PIN 1. ANOD 2. BASE 2. NO CC 3. COLLECTOR 3. CATHO	ONNECTION	
STYLE 9: PIN 1. ANODE 2. ANODE 3. CATHODE	STYLE 10: PIN 1. DRAIN 2. SOURCE 3. GATE	STYLE 11: STYLE 12: PIN 1. ANODE PIN 1. CATHO 2. CATHODE 2. CATHO 3. CATHODE-ANODE 3. ANODO	ODE 2. DRAIN 2. GATE	
STYLE 15: PIN 1. GATE 2. CATHODE 3. ANODE	STYLE 16: PIN 1. ANODE 2. CATHODE 3. CATHODE	STYLE 17: STYLE 18: PIN 1. NO CONNECTION PIN 1. NO CO 2. ANODE 2. CATHO 3. CATHODE 3. ANODO	ODE 2. ANODE 2. ANODE	
STYLE 21: PIN 1. GATE 2. SOURCE 3. DRAIN	STYLE 22: PIN 1. RETURN 2. OUTPUT 3. INPUT	STYLE 23: STYLE 24: PIN 1. ANODE PIN 1. GATE 2. ANODE 2. DRAIN 3. CATHODE 3. SOURCE		CTION
STYLE 27: PIN 1. CATHODE 2. CATHODE 3. CATHODE	STYLE 28: PIN 1. ANODE 2. ANODE 3. ANODE			

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